

» User Guide «

CP6004X-SA

6U CompactPCI Processor Board based on the 3rd Generation Intel® Core[™] i7 Processor with the Intel® QM77 Express Chipset

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Caution, Electric Shock!

This symbol and title warn of hazards due to electrical shocks (> 60V) when touching products or parts of them. Failure to observe the precautions indicated and/or prescribed by the law may endanger your life/health and/or result in damage to your material.

Please refer also to the section "High Voltage Safety Instructions" on the following page.



Warning, ESD Sensitive Device!

This symbol and title inform that electronic boards and their components are sensitive to static electricity. Therefore, care must be taken during all handling operations and inspections of this product, in order to ensure product integrity at all times.

Please read also the section "Special Handling and Unpacking Instructions" on the following page.



Warning!

This symbol and title emphasize points which, if not fully understood and taken into consideration by the reader, may endanger your health and/or result in damage to your material.



Note ...

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Caution, Electric Shock!

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Special Handling and Unpacking Instructions



ESD Sensitive Device!

Electronic boards and their components are sensitive to static electricity. Therefore, care must be taken during all handling operations and inspections of this product, in order to ensure product integrity at all times.

Do not handle this product out of its protective enclosure while it is not used for operational purposes unless it is otherwise protected.

Whenever possible, unpack or pack this product only at EOS/ESD safe work stations. Where a safe work station is not guaranteed, it is important for the user to be electrically discharged before touching the product with his/her hands or tools. This is most easily done by touching a metal part of your system housing.

It is particularly important to observe standard anti-static precautions when changing piggybacks, ROM devices, jumper settings etc. If the product contains batteries for RTC or memory backup, ensure that the board is not placed on conductive surfaces, including anti-static plastics or sponges. They can cause short circuits and damage the batteries or conductive circuits on the board.

General Instructions on Usage

In order to maintain Kontron's product warranty, this product must not be altered or modified in any way. Changes or modifications to the device, which are not explicitly approved by Kontron and described in this manual or received from Kontron's Technical Support as a special handling instruction, will void your warranty.

This device should only be installed in or connected to systems that fulfill all necessary technical and specific environmental requirements. This applies also to the operational temperature range of the specific board version, which must not be exceeded. If batteries are present, their temperature restrictions must be taken into account.

In performing all necessary installation and application operations, please follow only the instructions supplied by the present manual.

Keep all the original packaging material for future storage or warranty shipments. If it is necessary to store or ship the board, please re-pack it as nearly as possible in the manner in which it was delivered.

Special care is necessary when handling or unpacking the product. Please consult the special handling and unpacking instruction on the previous page of this manual.

Two Year Warranty

Kontron grants the original purchaser of Kontron's products a **TWO YEAR LIMITED HARDWARE WARRANTY** as described in the following. However, no other warranties that may be granted or implied by anyone on behalf of Kontron are valid unless the consumer has the express written consent of Kontron.

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If the customer's eligibility for warranty has not been voided, in the event of any claim, he may return the product at the earliest possible convenience to the original place of purchase, together with a copy of the original document of purchase, a full description of the application the product is used on and a description of the defect. Pack the product in such a way as to ensure safe transportation (see our safety instructions).

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Introduction



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1. Introduction

1.1 Board Overview

The CP6004X-SA (Standard Air-Cooled) is a highly integrated 6U CompactPCI system controller board based on the 3rd generation Intel® Core[™] i7 processor combined with the mobile Intel® QM77 Express Chipset.

The board supports the Intel® Core™ i7-3615QE quad-core processor with 2.3 GHz built on 22nm technology and provided in a BGA package. The processor is soldered on the CP6004X-SA which results in a higher Mean Time Between Failures (MTBF) and a significant improvement in cooling.

Two SODIMM sockets are available on the CP6004X-SA to provide up to 16 GB dual-channel, DDR3 memory with Error Checking and Correction (ECC) running at 1600 MHz. The graphics controller and the memory controller are integrated in the processor. Furthermore, either one 2.5" HDD/SSD or up to 64 GB NAND flash memory (SSD) via a SATA Flash module can be integrated onto the CP6004X-SA.

For maximum application flexibility, the CP6004X-SA comes with an extensive range of interfaces such as up to five Gigabit Ethernet ports (three on front I/O and two on rear I/O in compliance with PICMG 2.16), three high-resolution graphics interfaces (VGA, 2 x HDMI/DVI), two COM ports (RS-232 on front and rear I/O), and six SATA interfaces with RAID 0/1/5/10 functionality, one for the onboard SATA connector, one for the SATA Flash module or the 2.5" HDD/ SSD, and four for rear I/O. In addition, six USB 2.0 ports are available on the board, two on front I/O and four on rear I/O.

Support for one XMC module ensures individual system expansion via the XMC interface utilizing a x8 lane PCI Express 2.0 interconnection.

The board supports a configurable 64-bit/66 MHz PCI or PCI-X hot swap CompactPCI interface. When installed in the system slot, the interface is enabled, and when installed in a peripheral slot, the CP6004X-SA is isolated from the CompactPCI bus.

In addition, the CP6004X-SA provides support for high-speed serial rear I/O interconnection via two 10GBASE-KR ports and one x4 PCI Express 2.0 port operating at up to 5 GT/s. In general, the high-speed serial rear I/O interconnection is capable of supporting two 10GBASE-KR/ 40GBASE-KR4 ports, one x8 PCI Express 3.0 port operating at 8 GT/s, and two SATA 6 Gb/s ports. The mechanical implementation and the signal definition of the high-speed serial rear I/O interconnection is compliant with the PICMG 2.20 specification. The CP6004X-SA is also compliant with the PICMG 2.16 specification and provides support for Kontron's latest 6U rear transition modules. The CP6004X-SA has been designed for use in a Kontron CompactPCI backplane based on the PICMG 2.20 and PICMG 2.16 specifications.

Safety and security features via a Trusted Platform Module (TPM) 1.2 are provided on request. Intelligent Platform Management Interface (IPMI) is supported as well.

Designed for stability, the board fits into applications situated in industrial environments, including I/O intensive applications where only one slot is available for the CPU, making it a perfect core technology for long-life applications. Components with high temperature tolerance have been selected from embedded technology programs, and therefore offer long-term availability.

The board is offered with various Board Support Packages including Windows, VxWorks and Linux operating systems. For further information concerning the operating systems available for the CP6004X-SA, please contact Kontron.



1.2 Board-Specific Information

The CP6004X-SA is a CompactPCI single-board computer based on the 3rd generation Intel® Core[™] i7 processor and specifically designed for use in highly integrated platforms with solid mechanical interfacing for a wide range of industrial environment applications.

Some of the CP6004X-SA's outstanding features are:

- Support for the Intel[®] Core[™] i7-3615QE (SV) quad-core processor, 2.3 GHz, 6 MB L3 cache
- Intel® QM77 Express Chipset
- Up to 16 GB, dual-channel, DDR3 SDRAM memory with ECC running at 1600 MHz on two SODIMM sockets
- Integrated 3D high-performance graphics controller with three high-resolution graphics interfaces (VGA, 2 x HDMI/DVI)
- 64-bit/66 MHz PCI or PCI-X CompactPCI interface (PICMG 2.0)
- One XMC slot utilizing a x8 lane PCI Express 2.0 interconnection
- Five Gigabit Ethernet interfaces:
 - Three Gigabit Ethernet interfaces on front I/O
 - Two Gigabit Ethernet interfaces on rear I/O (PICMG 2.16)
- Two Gigabit Ethernet (GbE) controllers:
 - One Intel® 82579LM Gigabit Ethernet controller connected to one GbE port on the front panel
 - One Intel® I350 quad-port Gigabit Ethernet controller connected to two GbE ports on the front panel and two GbE ports on the rear I/O
- Two 10 Gigabit Ethernet interfaces (10GBASE-KR) on the rear I/O (PICMG 2.20)
- One Intel® 82599 dual-port 10 Gigabit Ethernet controller
- Six SATA interfaces with SATA RAID 0/1/5/10 support:
 - One onboard SATA 6 Gb/s interface for the standard SATA onboard connector
 - One onboard SATA 6 Gb/s interface for either one SATA Flash module or one SATA 2.5" HDD/SSD
 - Four SATA 3 Gb/s interfaces on the rear I/O
- Six USB ports:
 - Two USB 2.0 ports on the front panel
 - Four USB 2.0 ports on the rear I/O
- Two COM ports:
 - One RS-232 COM port either on the front panel or on the rear I/O (COMA)
 - One RS-232 COM port on the rear I/O (COMB)
- TCG 1.2 compliant Trusted Platform Module (TPM), on request
- Two SPI boot flashes for two separate uEFI BIOS images:
 - One standard SPI boot flash
 - One recovery SPI boot flash
- Watchdog timer
- Battery-backed real-time clock (RTC)
- Three onboard DIP switches for board configuration
- Supports PICMG Packet Switching Backplane Specification 2.16
- IPMI support
- 4HP, 6U CompactPCI
- · Passive heat sink solution for forced-airflow cooling
- Rear I/O on J3 and J5
- High-speed interconnect serial rear I/O on J4 and J41 (PICMG 2.20)
- Hot swap capability: as system controller or as peripheral device
- AMI Aptio®, a uEFI-compliant platform firmware



1.3 System Expansion Capabilities

1.3.1 XMC Module

The CP6004X-SA has one XMC mezzanine interface for support of x1, x4 and x8 PCI Express 2.0 XMC modules providing an easy and flexible way to configure the CP6004X-SA for various application requirements. For information on the XMC interface, refer to chapter 2.10.9, "XMC Interface".

1.3.2 CP6004X-SA-MK2.5SATA Assembly Kit

The CP6004X-SA comes with an optional CP6004X-SA-MK2.5SATA assembly kit comprised of one MMADP-SATA01 module and the necessary components needed for mounting the module on the CP6004X-SA. The MMADP-SATA01 module is required for connecting an onboard 2.5" SATA HDD or SSD to the CP6004X-SA via an onboard SATA extension connector. For further information concerning the MMADP-SATA01 module, please refer to Appendix A.

1.3.3 SATA Flash Module

The CP6004X-SA provides support for up to 64 GB NAND flash memory in combination with an optional SATA Flash module, which is connected to the CP6004X-SA via an onboard SATA extension connector. For further information concerning the SATA Flash module, please refer to Appendix B.

1.3.4 Rear I/O Module

The CP6004X-SA provides support for one rear I/O module via the CompactPCI rear I/O connectors. For further information about the compatibility of rear I/O modules with the CP6004X-SA, please refer to the CP6004X-SA datasheet.

1.4 Board Diagrams

The following diagrams provide additional information concerning board functionality and component layout.

Introduction



1.4.1 Functional Block Diagram

Figure 1-1: CP6004X-SA Functional Block Diagram



Introduction



1.4.2 Front Panel



Figure 1-2: CP6004X-SA Front Panel

Legend

IPMI LEDs I0/I1 (red/green):

Indicate the software status of the IPMI controller

Status LEDs

WD (green):	Watchdog Status
TH (red/green):	Temperature Status
HS (blue):	Hot Swap Control

Integral Ethernet LEDs

ACT (green): Ethernet Link/Activity SPEED (green/orange/off): Ethernet Speed

General Purpose LEDs

LED 0..3 (red/green/amber): General Purpose/POST code



Note ...

If the General Purpose LEDs are lit red during boot-up, a failure is indicated before the uEFI BIOS has started.

For further information, please contact Kontron.

1.4.3 Board Layout

Figure 1-3: CP6004X-SA Board Layout – Top View



CP6004X-SA







1.5 Technical Specification

Table 1-1: CP6004X-SA Main Specifications

FEATURES		SPECIFICATIONS
Processor and Memory	CPU	 The CP6004X-SA supports the Intel® Core™ i7-3615QE (SV) quad-core processor with 2.3 GHz and 6 MB L3 cache Further processor features: Up to four execution cores Intel® Hyper-Threading Technology (Intel® HT Technology) Intel® 64 Architecture Intel® Advanced Vector Extensions (AVX) floating point Intel® Turbo Boost Technology 2.0 Intel® Intelligent Power Sharing (IPS) System memory interface with optimized support for dual-channel DDR3 SDRAM memory at 1600 MHz with ECC Integrated 2D and 3D Graphics Engines DMI 2.0 with 5 GT/s and FDI interfaces to the Intel® QM77 Chipset One x8 and two x4 PCI Express 2.0 ports operating at 5 GT/s Please contact Kontron for further information concerning the suitability of other Intel processors for use with the CP6004X-SA.
	Memory	 Main memory: Up to 16 GB, dual-channel DDR3 SDRAM memory with ECC running at 1600 MHz on two SODIMM sockets Cache structure: 64 kB L1 cache for each core 32 kB instruction cache 32 kB data cache 256 kB L2 shared instruction/data cache for each core Up to 6 MB L3 shared instruction/data cache Flash memory: Two SPI boot flash chips (2 x 8 MB) for two separate uEFI BIOS images Up to 64 GB NAND flash via an onboard SATA Flash module (SSD) Serial EEPROM with 64 kbit



Table 1-1:	CP6004X-SA Main S	pecifications ((Continued)

FEATURES		SPECIFICATIONS
Chipset	Intel® QM77	 Mobile Intel® QM77 Express Chipset: Two x4 or eight x1 PCI Express 2.0 ports operating at 5 GT/s (only one x2 and one x4 PCI Express ports are used on the CP6004X-SA) SATA host controller with six ports and RAID 0/1/5/10 support Two SATA 6 Gb/s ports accessible via onboard connectors Four SATA 3 Gb/s ports accessible via rear I/O USB 2.0 host interface with up to 14 USB ports available (only six ports are used on the CP6004X-SA) USB 3.0 host interface with up to 4 USB ports available (not used on the CP6004X-SA) Integrated Ethernet controller SPI flash interface support Low Pin Count (LPC) interface Power management logic support Enhanced DMA controller, interrupt controller, and timer functions System Management Bus (SMBus) compatible with most I²CTM devices DMI 2.0 with 5 GT/s and FDI interfaces to the processor High Definition Audio (HDA) interface Analog display port Three digital display ports Integrated RTC
Integrated Controller	Graphics controller	 High-performance 3D graphics controller integrated in the processor: Supports analog displays (CRT) up to a resolution of 2048 x 1536 pixels with 32-bit color @ 75 Hz Supports digital displays (HDMI/DVI) up to a resolution of 1920 x 1200 pixels @ 60 Hz Dynamic Video Memory Technology (DVMT)
Interfaces	CompactPCI	 Compliant with CompactPCI Specification PICMG 2.0 R 3.0: System controller operation 64-bit/66 MHz PCI or PCI-X master interface with dedicated PCIe-to-PCI-X bridge 3.3V or 5V signaling levels (universal signaling support) Compliant with the Packet Switching Specification PICMG 2.16. The CP6004X-SA supports System Master hot swap functionality and application-dependent hot swap functionality when used in a peripheral slot. When used as a System Master, the CP6004X-SA supports individual clocks for each slot and the ENUM signal handling is in compliance with the PICMG 2.1 Hot Swap Specification. When installed in a peripheral slot, the CP6004X-SA is isolated from the CompactPCI bus. It receives power from the backplane and supports rear I/O and, if the system supports it, packet switching (in this case up to two channels of Gigabit Ethernet).

Introduction

Table 1-1:	CP6004X-SA Main Specifications (Continued)
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FEATURES		SPECIFICATIONS
	Standard Rear I/O	 The following interfaces are routed to the rear I/O connectors J3 and J5. COMA (RS-232 signaling) and COMB (RS-232 signaling); no buffer on the rear I/O module is necessary 4 x USB 2.0 1 x CRT VGA, 2 x HDMI/DVI 1 x HDA 2 x Gigabit Ethernet (compliant with PICMG 2.16, R 1.0) 4 x SATA 3 Gb/s 4 x GPIs and 4 GPOs (LVTTL signaling) System write protection
	High-Speed Serial Rear I/O Interconnection	 The following interfaces are provided on the rear I/O via two ZDplus high-speed connectors, J4 and J41 (PICMG 2.20): Two 10GBASE-KR interfaces One x4 PCI Express 2.0 operating at 5 GT/s as a root complex controller only The port mapping of the high-speed serial rear I/O interconnection on the CP6004X-SA is capable of supporting two 10GBASE-KR/40GBASE-KR4 interfaces, one x8 PCI Express 3.0 operating at 8 GT/s, and two SATA 6 Gb/s ports. However, the current implementation provides support for only two 10GBASE-KR and one x4 PCI Express 2.0 operating at 5 GT/s.
ces	10 Gigabit Ethernet	Two 10GBASE-KR interfaces for high-speed serial rear I/O interconnection based on the Intel® 82599 dual-port 10 Gigabit Ethernet controller
Interfaces	Gigabit Ethernet	 Five 10 Base-T/100 Base-TX/1000 Base-T Gigabit Ethernet interfaces based on one Intel® 82579LM Gigabit Ethernet controller and one Intel® 1350 quad-port Gigabit Ethernet controller: Three RJ-45 connectors on the front panel Two ports on the rear I/O (PICMG 2.16) Automatic mode recognition (Auto-Negotiation) Automatic cabling configuration recognition (Auto-MDI/X)
	USB	 Six USB ports supporting UHCI (USB 1.1) and EHCI (USB 2.0): Two type A USB 2.0 connectors on the front panel Four USB 2.0 ports on the rear I/O interface
	Serial	 Two 16C550-compatible UARTs: One RS-232 port on the front panel and routed to rear I/O, COMA One RS-232 port on the rear I/O, COMB
	ХМС	 XMC interface: One onboard XMC connector for connecting a standard XMC module Up to x8 lanes PCI Express 2.0 ports operating at 5 GT/s
	SATA	 Two SATA 6 Gb/s interfaces for: Up to 64 GB flash memory via an onboard SATA Flash module, or Onboard 2.5" HDD/SSD is supported in combination with the MMADP-SATA01 module One standard SATA 6 Gb/s interface for the standard SATA connector Four SATA 3 Gb/s ports accessible via rear I/O



Table 1-1: CP6004X-SA Main Specifications (Continued)

FEATURES		SPECIFICATIONS		
	Front Panel Connectors	 VGA: 15-pin, D-Sub connector, J9 USB: two 4-pin, type A connectors, J6 and J7 Ethernet: three 8-pin, RJ-45 connectors, J10, J11 and J12 Serial port: one 8-pin, RJ-45 connector, J8 (COMA) XMC front panel bezel cutout 		
Sockets	Onboard Connectors	 XMC connector, J20 (P15) Two SATA connectors One 7-pin, standard SATA connector, J14 One 34-pin, SATA extension connector, J17 JTAG connector, J16 Debug connector, J15 XDP-SFF (debug) connector, J25 CompactPCI connectors J1, J2, J3 and J5 ZDplus high-speed serial rear I/O connectors, J4 and J41 (PICMG 2.20) Two 204-pin DDR3 SODIMM sockets, J18 and J19 		
S	DIP Switches	Two onboard DIP switches, SW1 and SW2 for board configuration		
Switches	Reset Switch	One front panel hardware reset switch		
Swi	Hot Swap Switch	One switch for hot swap purposes integrated in the front panel handle in accordance with PICMG 2.1 Rev. 2.0.		
LEDS	System LEDs	System Status LEDs: Indicate the software status of the IPMI controller WD (green): Watchdog Status TH (red/green): Temperature Status HS (blue): Hot Swap Control General Purpose LEDs: Hot Swap Control		
	Ethernet LEDs	 LED 03 (red/green/amber): General Purpose/POST code Gigabit Ethernet Status: ACT (green): Ethernet Link/Activity SPEED (green/orange/off): Ethernet Speed 		
	Watchdog Timer	 Software-configurable, two-stage Watchdog with programmable timeout ranging from 125 ms to 4096 s in 16 steps Serves for generating IRQ or hardware reset 		
Timer	System Timer	 The Intel® QM77 Chipset contains three 8254-style counters which have fixed uses In addition to the three 8254-style counters, the Intel® QM77 Chipset includes eight individual high-precision event timers that may be used by the operating system. They are implemented as a single counter each with its own comparator and value register. 		

FEATURES		SPECIFICATIONS		
IMGI	IPMI Controller	 NXP® ARM7 microcontroller with redundant 512 kB firmware flash and automatic roll-back strategy The IPMI controller carries out IPMI commands such as monitoring several onboard temperature conditions, board voltages and the power supply status, and managing hot swap operations. The IPMI controller is accessible via two IPMBs (through the J1 and J2 connectors) and one host Keyboard Controller Style (KCS) Interface. 		
Thermal	Thermal Management	 CPU and board overtemperature protection is provided by: Temperature sensors integrated in the 3rd generation Intel[®] Core[™] i7 processor: One temperature sensor for monitoring each processor core One temperature sensor for monitoring the graphics core One temperature sensor for monitoring the package die temperature One temperature sensor integrated in the Intel[®] QM77 Chipset for monitoring the chipset One onboard temperature sensor for monitoring the board temperature Specially designed heat sink 		
Security	ТРМ	Trusted Platform Module (TPM) 1.2 for enhanced hardware- and software- based data and system security (on request)		
Software	uEFI BIOS	 AMI Aptio[®], AMI's next-generation BIOS firmware based on the uEFI Specification and the Intel Platform Innovation Framework for EFI. LAN boot capability for diskless systems (standard PXE) Redundant image; automatic fail-safe recovery in case of a damaged image Non-volatile storage of setting in the SPI boot flash (battery only required for the RTC) Compatibility Support Module (CSM) providing legacy BIOS compatibility based on AMIBIOS8 Command shell for diagnostics and configuration uEFI shell commands executable from mass storage device in a Pre-OS environment (open interface) IPMI support in the command shell 		
	Software IPMI	 IPMI firmware providing the following features: The IPMI controller is accessible via up to two IPMBs, IOL and one KCS interface with interrupt support The IPMI firmware can be updated in the field through all supported onboard interfaces using the update functions of the open-source tool "ipmitool". For further information on the ipmitool refer to the sourceforge.net web site. Two IPMI controller flash banks with automatic roll-back capability in case of an upgrade firmware failure Board supervision and control extensions such as board reset, power and SPI boot flash control, etc. 		
	Operating Systems	The board is offered with various Board Support Packages including Windows, VxWorks and Linux operating systems. For further information concerning the operating systems available for the CP6004X-SA, please contact Kontron.		



FEATURES		SPECIFICATIONS			
	Mechanical	6U, 4HP, CompactPCI-compliant form factor			
	Power Consumption	See Chapter 5 for details.			
	Temperature Ranges	Operational: 0°C to +60°C Standard			
		Storage: -40°C to +85°C Without hard disk and without battery			
		NoteWhen a battery is installed, refer to the operational specifica- tions of the battery as this determines the storage tempera- ture of the CP6004X-SA (See "Battery" below).			
General		NoteWhen additional components are installed, refer to their opera- tional specifications as this will influence the operational and stor- age temperature of the CP6004X-SA.			
	Battery	3.0V lithium battery for RTC with battery socket.			
		Battery type: UL-approved CR2025			
	Temperature ranges:				
		Operational: -20°C to +70°C typical (refer to the battery manufacturer's specifications for exact range)			
		Storage: -55°C to +70°C typical (no discharge)			
	Climatic Humidity	93% RH at 40 °C, non-condensing (acc. to IEC 60068-2-78)			
	Dimensions	233.35 mm x 160 mm			
	Board Weight	799 g (without mezzanine cards)			

Table 1-1: CP6004X-SA Main Specifications (Continued)

1.6 Standards

The board complies with the requirements of the following standards:

Table 1-2: Standards

ТҮРЕ	ASPECT	STANDARD	REMARKS
CE	Emission	EN55022 EN61000-6-3	
	Immission	EN55024 EN61000-6-2	
	Electrical Safety	EN60950-1	
Mechanical	Mechanical Dimensions	IEEE1101.10	
Environmental	Climatic Humidity	IEC60068-2-78	93% RH at 40°C, non-condensing (see note below)
	WEEE	Directive 2002/96/EC	Waste electrical and electronic equipment
	RoHS 2	Directive 2011/65/EU	Restriction of the use of certain hazardous sub- stances in electrical and electronic equipment
	Vibration (Sinusoidal)	IEC60068-2-6	Ruggedized version test parameters: • 10-300 (Hz) frequency range • 2 (g) acceleration • 1 (oct/min) sweep rate • 10 cycles/axis • 3 axes
	Single Shock	IEC60068-2-27	Ruggedized version test parameters: • 30 (g) acceleration • 9 (ms) shock duration half sine • 3 number of shocks per direction (total: 18) • 6 directions • 5 (s) recovery time
	Permanent Shock	IEC60068-2-29	Ruggedized version test parameters: • 15 (g) acceleration • 11 (ms) shock duration half sine • 500 number of shocks per direction • 6 directions • 5 (s) recovery time





Note ...

Kontron performs comprehensive environmental testing of its products in accordance with applicable standards.

Customers desiring to perform further environmental testing of Kontron products must contact Kontron for assistance prior to performing any such testing. This is necessary, as it is possible that environmental testing can be destructive when not performed in accordance with the applicable specifications.

In particular, for example, boards **without conformal coating** must not be exposed to a change of temperature exceeding 1K/minute, averaged over a period of not more than five minutes. Otherwise, condensation may cause irreversible damage, especially when the board is powered up again.

Kontron does not accept any responsibility for damage to products resulting from destructive environmental testing.

1.7 Related Publications

The following publications contain information relating to this product.

Table 1-3: Related Publications

PRODUCT	PUBLICATION
CompactPCI Systems and Boards	CompactPCI Specification PICMG 2.0, Rev. 3.0 CompactPCI Packet Switching Backplane Specification PICMG 2.16 Rev. 1.0 CompactPCI Packet Serial Mesh Backplane Specification PICMG 2.20 Rev. 1.0 CompactPCI System Management Specification PICMG 2.9 Rev. 1.0
	CompactPCI Hot Swap Specification PICMG 2.1 Rev. 2.0 IPMI - Intelligent Platform Management Interface Specification v2.0 Kontron CompactPCI Backplane Manual, ID 24229
SATA	Serial ATA 1.0a Specification
XMC Module	ANSI/VITA 42.0-200x XMC Switched Mezzanine Card Auxiliary Standard ANSI/VITA 42.3-2006 XMC PCI Express Protocol Layer Standard IEEE 1386-2001, IEEE Standard for a Common Mezzanine Card (CMC) Family
Platform Firmware	Unified Extensible Firmware Interface (uEFI) Specification, Version 2.1
All Kontron products	Product Safety and Implementation Guide, ID 1021-9142
Kontron	CP6004-SA/CP6004X-SA uEFI BIOS User Guide
	CP6004-SA/CP6004X-SA IPMI Firmware User Guide



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